

# MP6K32-VB Datasheet Dual N-Channel 60 V (D-S) 175 °C MOSFET

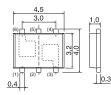
PRODUCT SUMMARY	
V <sub>DS</sub> (V)	60
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.033
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.045
I <sub>D</sub> (A) per leg	7
Configuration	Dual

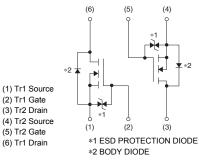
#### FEATURES

- Trench power MOSFET
- 100 %  $\rm R_g$  and UIS tested



#### • Dimensions (Unit : mm)





<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	60	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20		
Continuous Drain Current	T <sub>C</sub> = 25 °C	- I <sub>D</sub>	7		
	T <sub>C</sub> = 125 °C		4		
Continuous Source Current (Diode Conduction) a		۱ <sub>S</sub>	3.6	А	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	28		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	18		
Single Pulse Avalanche Energy		E <sub>AS</sub>	16.2	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	Р	4	W	
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	1.3	٧٧	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	110	°C/W	
Junction-to-Foot (Drain)		R <sub>thJF</sub>	34	0/10	

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. When mounted on 1" square PCB (FR4 material).

PARAMETER         Static         Drain-Source Breakdown Voltage         Gate-Source Threshold Voltage         Gate-Source Leakage	SYMBOL V <sub>DS</sub> V <sub>GS(th)</sub> I <sub>GSS</sub>		T CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Drain-Source Breakdown Voltage Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =						
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =						
			$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		-	-	V	
Gate-Source Leakage	looo	V <sub>DS</sub> =	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		2.0	2.5		
	GSS	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1		
Zero Gate Voltage Drain Current		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	150		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	20	-	-	A	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 4.5 A	-	0.033	-	- Ω	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 10 V$	$I_D = 4.5 \text{ A}, T_J = 125 \text{ °C}$	-	0.066	-		
		$V_{GS} = 10 V$	$I_{\rm D} = 4.5 \text{ A}, T_{\rm J} = 175 \text{ °C}$	-	0.081	-		
Forward Transconductance <sup>f</sup>	~	$V_{GS} = 4.5 V$	$I_{D} = 4 A$	-	0.045 15	-	S	
Dynamic <sup>b</sup>	9 <sub>fs</sub>	VDS :	= 15 V, I <sub>D</sub> = 4.5 A	-	15	-	3	
-	0	[		_	000	750		
Input Capacitance	C <sub>iss</sub>		V <sub>DS</sub> = 25 V, f = 1 MHz		600	750	pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	110	140		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	50	62	ļ	
Total Gate Charge <sup>c</sup>	Qg		$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 5.3 \text{ A}$	-	11.7	18		
Gate-Source Charge <sup>c</sup>	$Q_gs$	V <sub>GS</sub> = 10 V		-	1.8	2.7	nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			-	2.8	4.2		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1.3	-	6	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD}=30~V,~R_L=6.8~\Omega$ $I_D\cong4.4~A,~V_{GEN}=10~V,~R_g=1~\Omega$		-	7	11		
Rise Time <sup>c</sup>	t <sub>r</sub>			-	3.3	5	- ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	22.4	33.5		
Fall Time <sup>c</sup>	t <sub>f</sub>			-	2.1	3.2		
Source-Drain Diode Ratings and Character	eristics <sup>b</sup>							
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	28	Α	
Forward Voltage	V <sub>SD</sub>	$I_{F} = 2 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.75	1.1	V	

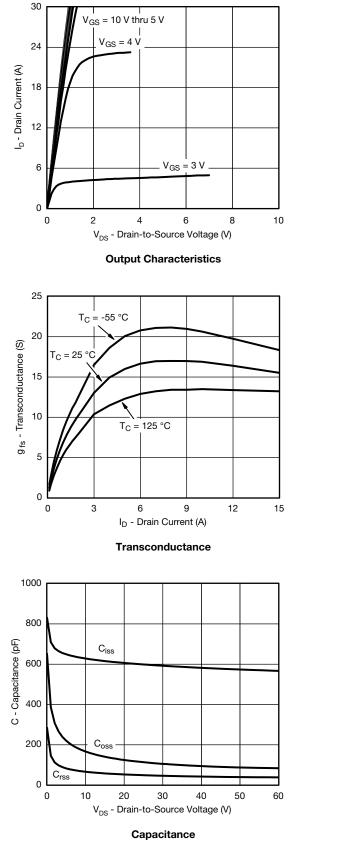
Notes

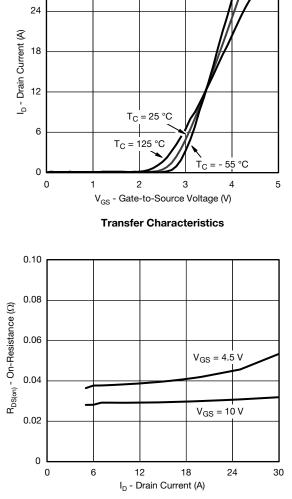
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

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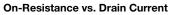


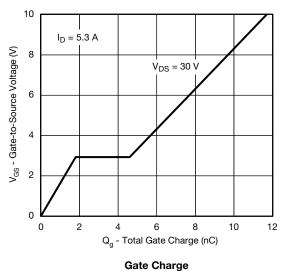
## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



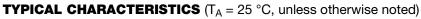


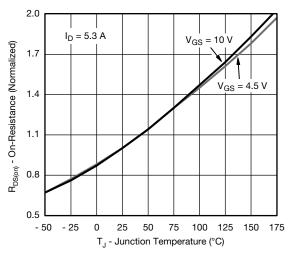
30



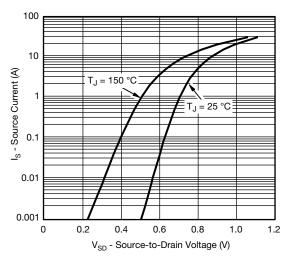




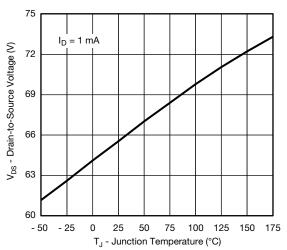




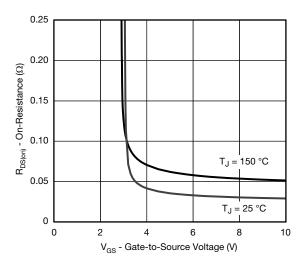
**On-Resistance vs. Junction Temperature** 



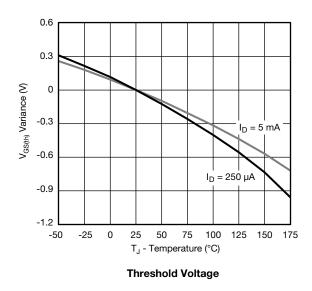
Source Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature

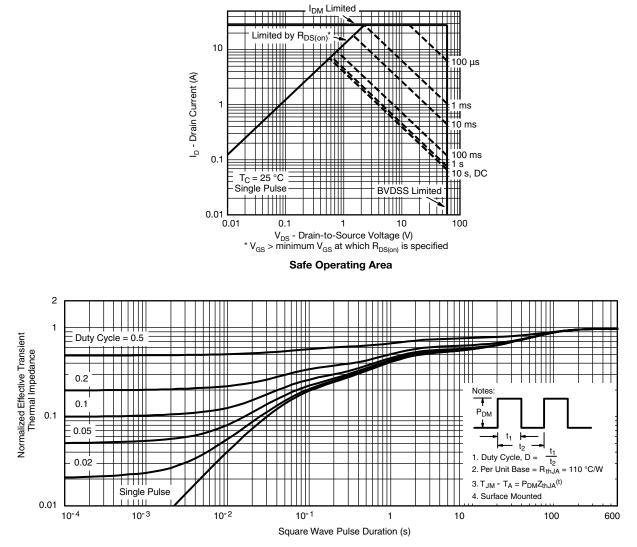


On-Resistance vs. Gate-to-Source Voltage





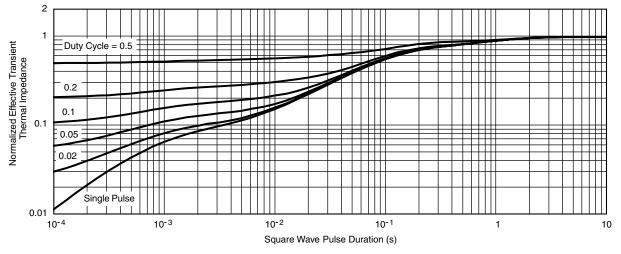
### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



## **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



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